

PS-D-266/1-5000mW



PICOSECOND PULSED LASER

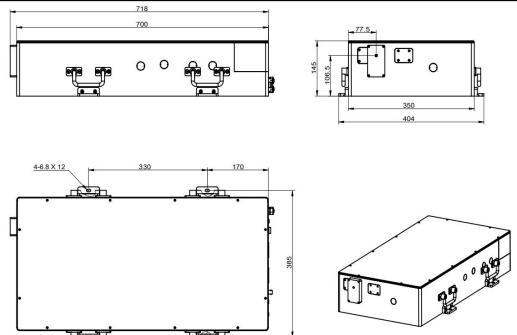
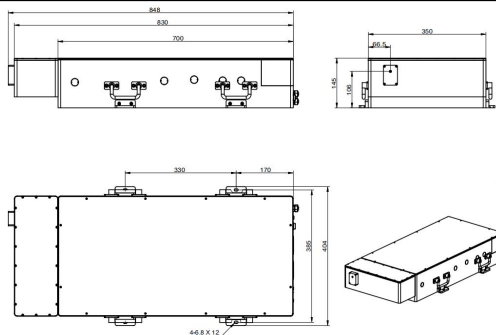
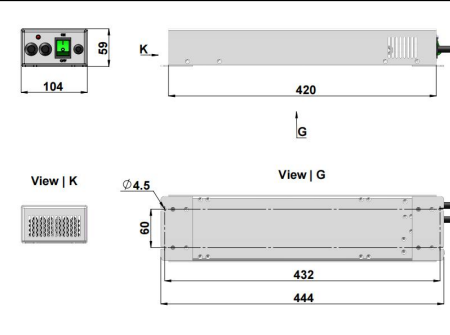
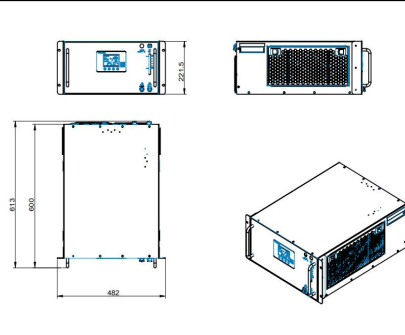
Picosecond pulsed laser is characterized by short pulse duration and good beam quality, which is used in glass marking, sapphire marking, ceramic cutting, semiconductor cutting, solar panel coating, film scribing, etc.



SPECIFICATIONS

Wavelength (nm)	266±1		
Output power (mW)	1-5000@1MHz	1000-4000@80MHz	500-3000@120MHz
Rep.rate ¹	400kHz-1MHz	80MHz±1	120MHz±1
Pulse duration (ps) ²	~10		
Power stability (rms, 4 hours ± 3°C)	<3%, <2%, <1%		
Transverse mode	TEM ₀₀		
Beam Circularity (%) ³	>90	>90	>85
Beam divergence, full angle (mrad)	<2		
Beam diameter at the at the aperture (1/e ² , mm)	~3	~2	
M ²	<1.2	<1.3	
Polarization ratio	>100:1 Horizontal (Vertical optional)		
Beam height from base plate (mm)	106.5 (PS-D-266-I)	106 (PS-D-266-II)	
Warm-up time (minutes)	≥30		
Cooling method	Water cooled		
Operating temperature (°C)	20-30		
Operating voltage (VDC)	36V/40A		
Expected lifetime (hours)	>10000		



LASER HEAD (Driver Integrated) (PS-D-266-I)	LASER HEAD (Driver Integrated) (PS-D-266-II)	POWER SUPPLY (100-240VAC)	WATER CHILLER (5U03)
 <p>718 (L) × 404 (W) × 145 (H) mm³, 57 kg</p>	 <p>848(L) × 404 (W) × 145 (H) mm³, 57 kg</p>	 <p>444 (L) × 104 (W) × 59 (H) mm³, 2.7 kg</p>	 <p>613(L) × 482 (W) × 221.5(H) mm³, 28 kg</p>

- 1 Other rep.rate range available on request.
- 2 Other pulse width available on request.
- 3 Better beam circularity available on request.